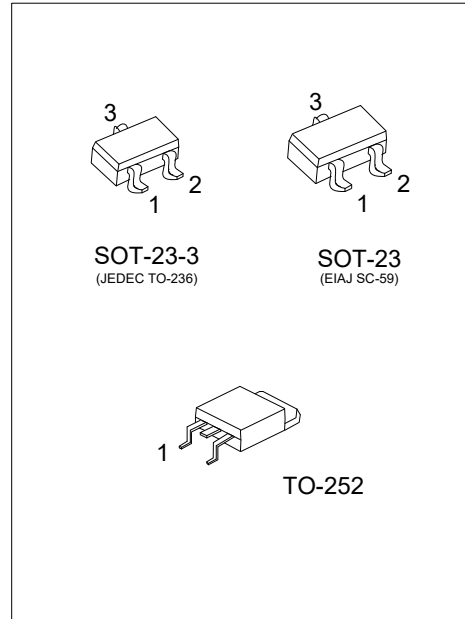
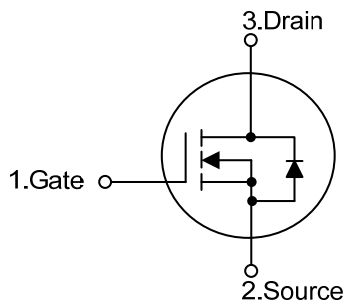


**UT1N10****Power MOSFET****1.0A, 100V N-CHANNEL
ENHANCEMENT MODE
POWER MOSFET****DESCRIPTION**

The UTC **UT1N10** is a N-channel power MOSFET providing very low on-resistance. It has high efficiency and perfect cost-effectiveness. It can be generally applied in the commercial and industrial fields.

FEATURES

- * $R_{DS(ON)} \leq 0.5 \Omega$ @ $V_{GS}=10V$, $I_D=0.5A$
- $R_{DS(ON)} \leq 0.55 \Omega$ @ $V_{GS}=4.5V$, $I_D=0.5A$
- * Simple drive requirement

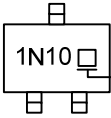
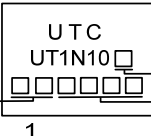
SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT1N10L-AE2-R	UT1N10G-AE2-R	SOT-23-3	G	S	D	Tape Reel
UT1N10L-AE3-R	UT1N10G-AE3-R	SOT-23	G	S	D	Tape Reel
UT1N10L-TN3-R	UT1N10G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

UT1N10G-AE2-R	(1)Packing Type	(1) R: Tape Reel
	(2)Package Type	(2) AE2: SOT-23-3, AE3: SOT-23, TN3: TO-252
	(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING

SOT-23 / SOT-23-3	TO-252
 1N10 L: Lead Free G: Halogen Free	 UTC UT1N10 Lot Code ← [] [] [] [] [] → Date Code 1 L: Lead Free G: Halogen Free

■ ABSOLUTE MAXIMUM RATING (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	I _D	1	A
	Pulsed (Note 2)	I _{DM}	2	A
Peak Diode Recovery dv/dt (Note 3)		dv/dt	1.9	V/ns
Power Dissipation (T _A =25°C)	SOT-23-3/SOT-23	P _D	0.3	W
	TO-252		1.5	W
Junction Temperature		T _J	+150	°C
Storage Temperature Range		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. I_{SD} ≤ 1.0A, di/dt ≤ 100 A/μs, V_{DD} ≤ V_{(BR)DSS}, T_J = 25°C.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-23-3/SOT-23	θ _{JA}	416 (Note)	°C/W
	TO-252		83.3 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

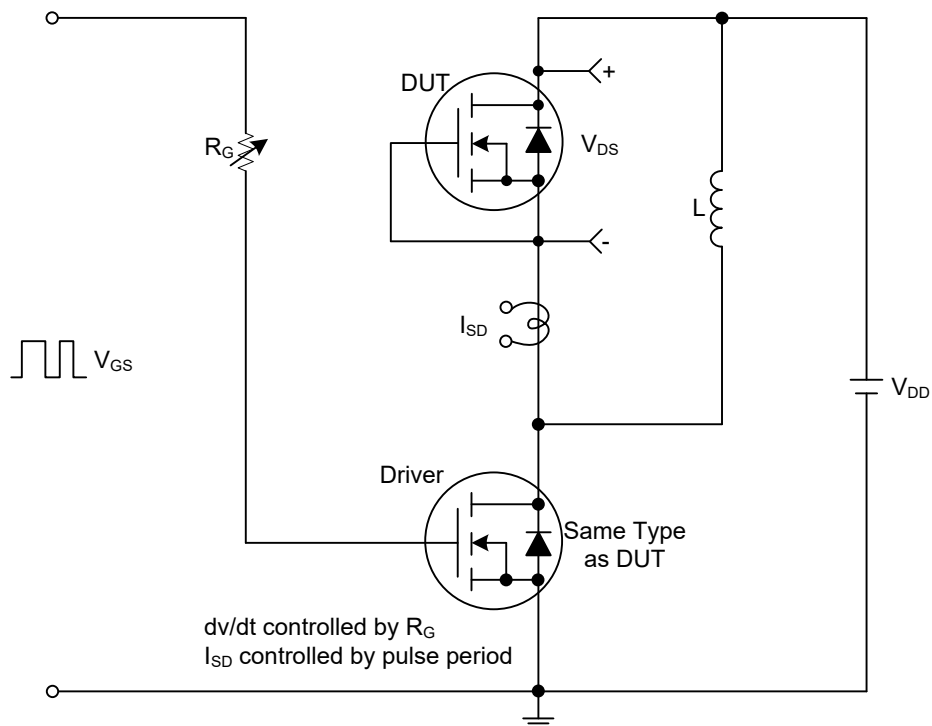
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	100			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	1.0		3.0	V
Drain to Source On-state Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =0.5A			0.5	Ω
		V _{GS} =4.5V, I _D =0.5A			0.55	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V, f =1.0MHz		150		pF
Output Capacitance	C _{OSS}			18		pF
Reverse Transfer Capacitance	C _{RSS}			12		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q _G	V _{DS} =80V, V _{GS} =10V, I _D =1A, I _G =1mA (Note 1, 2)		10		nC
Gate Source Charge	Q _{GS}			2		nC
Gate Drain Charge	Q _{GD}			1.6		nC
Turn-ON Delay Time (Note 1)	t _{D(ON)}	V _{DD} =50V, V _{GS} =10V, I _D =1A, R _G =25Ω (Note 1, 2)		4		ns
Turn-ON Rise Time	t _R			18		ns
Turn-OFF Delay Time	t _{D(OFF)}			14		ns
Turn-OFF Fall-Time	t _F			19		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =1A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)	t _{rr}	I _S =1A, V _{GS} =0V, dI/dt =100A/μs		32		ns
Reverse Recovery Charge	Q _{rr}			14		nC

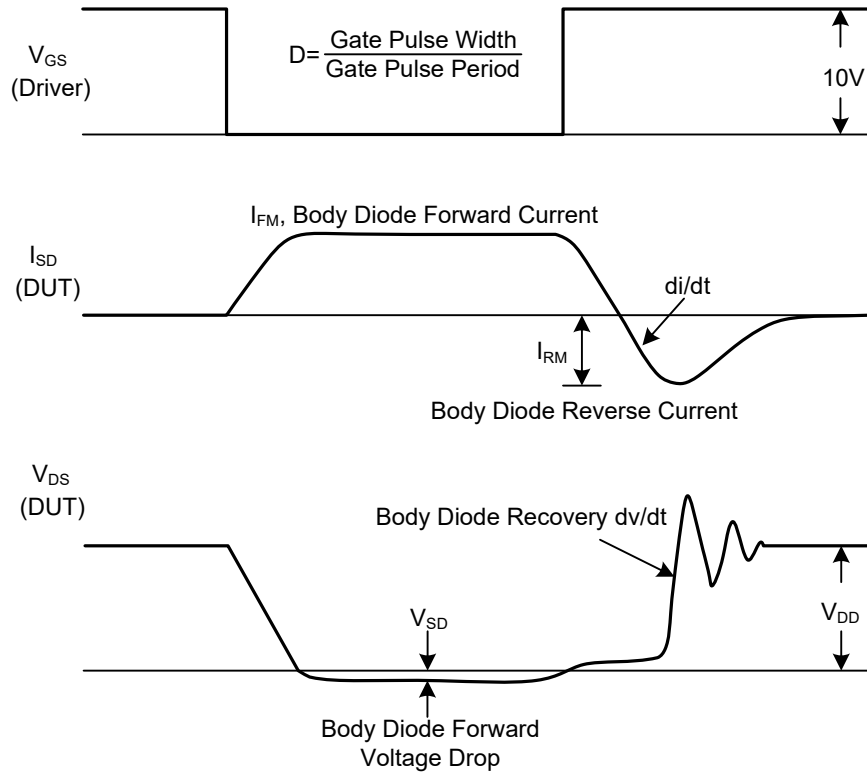
Notes: 1. Pulse Test : Pulse width ≤ 1000μs, Duty cycle ≤ 2%.

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS



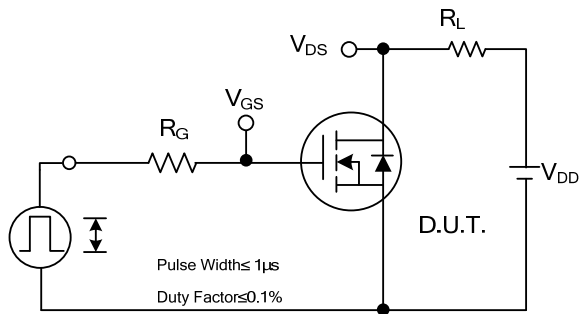
Peak Diode Recovery dv/dt Test Circuit



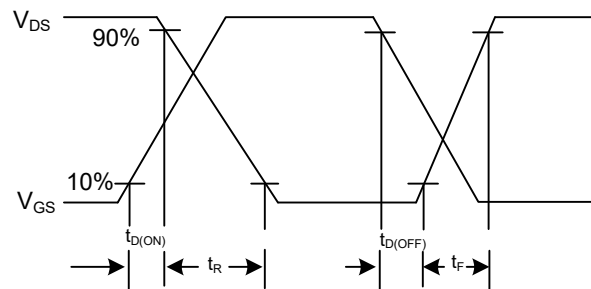
Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

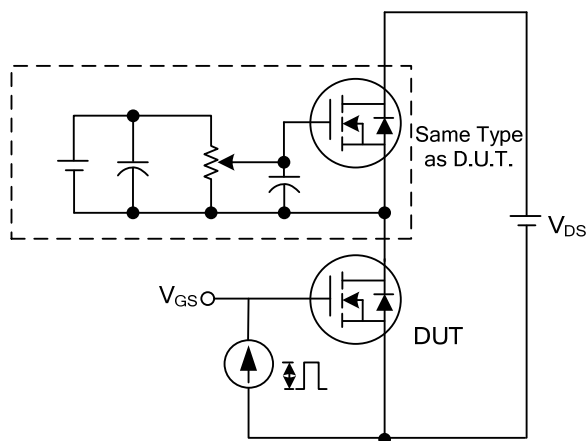
■ TEST CIRCUITS AND WAVEFORMS



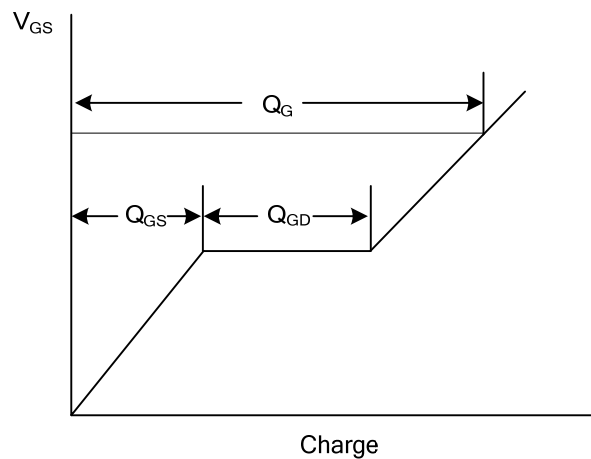
Switching Test Circuit



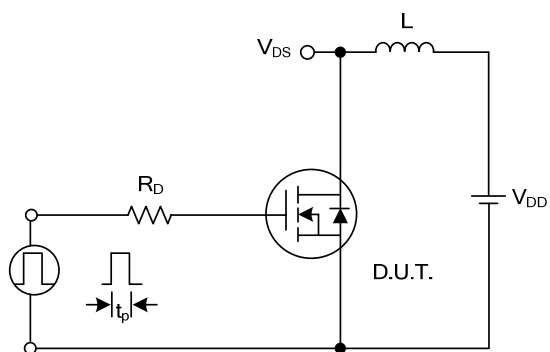
Switching Waveforms



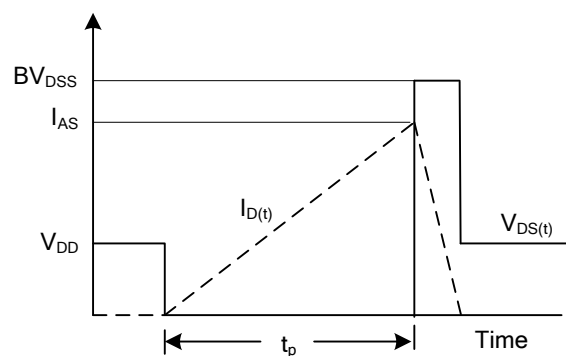
Gate Charge Test Circuit



Gate Charge Waveform

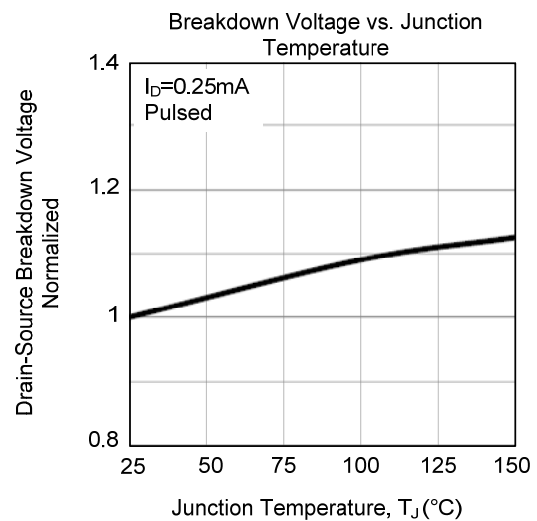
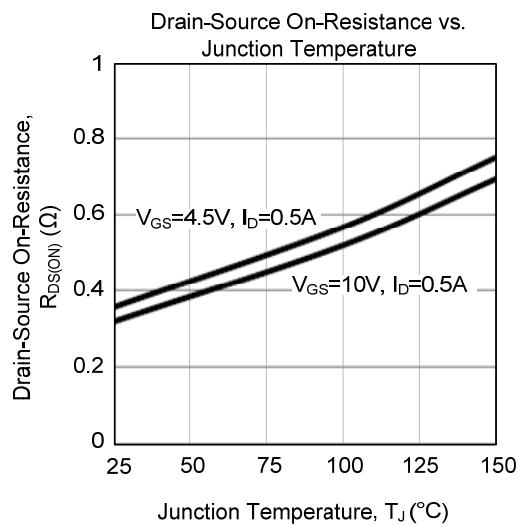
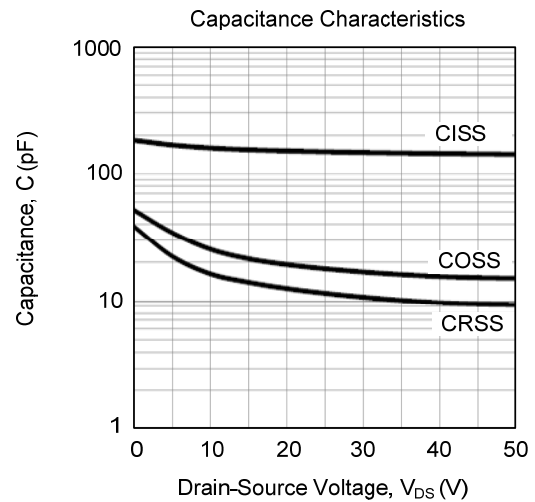
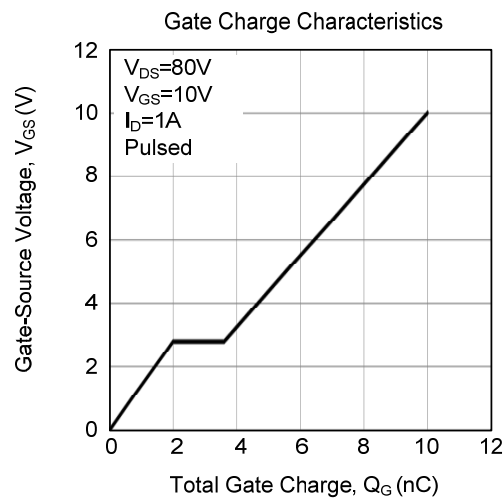
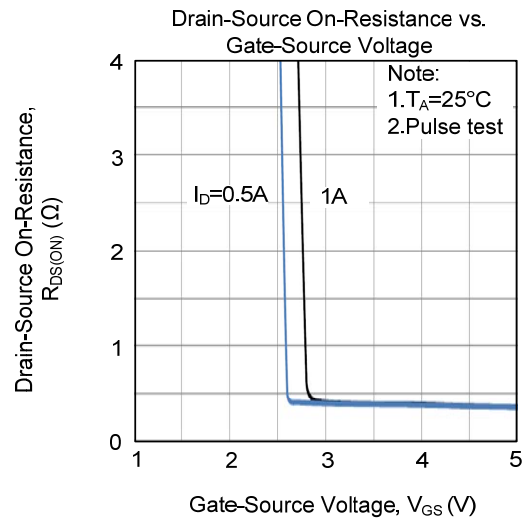
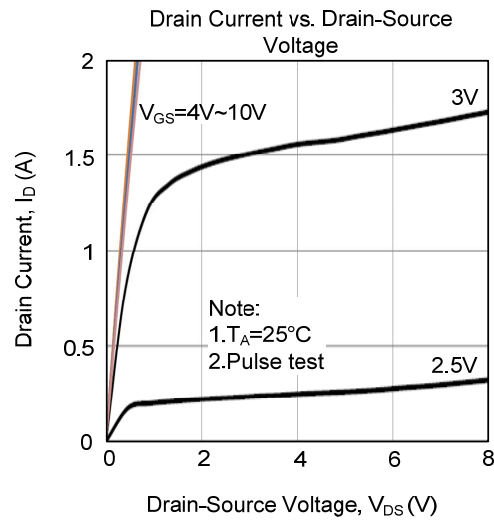


Unclamped Inductive Switching Test Circuit

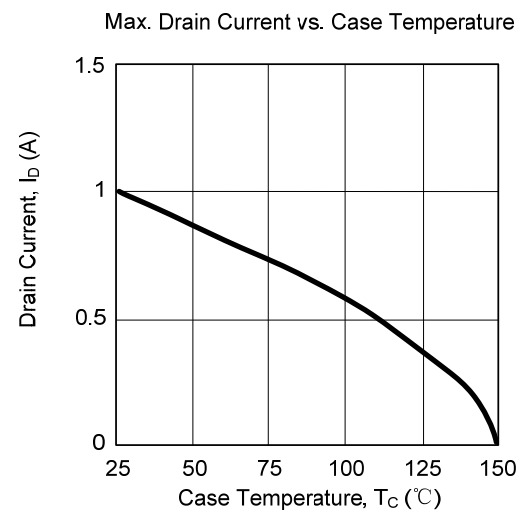
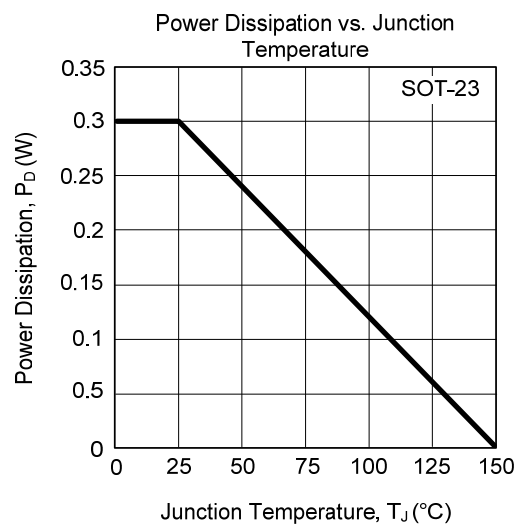
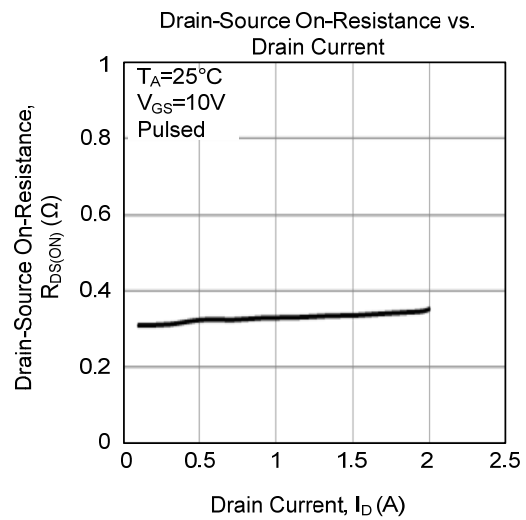
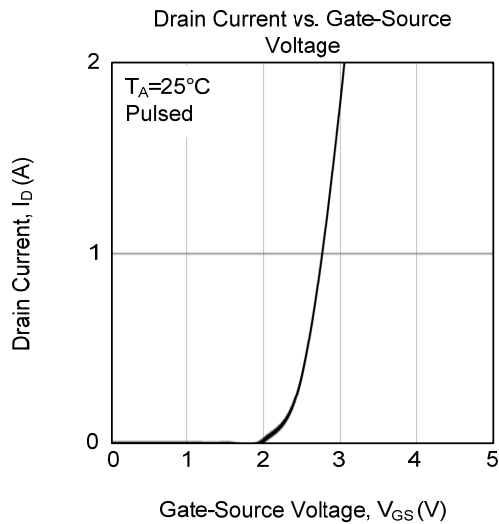
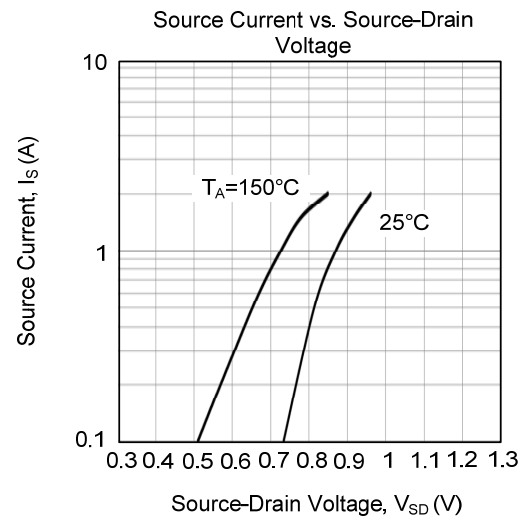
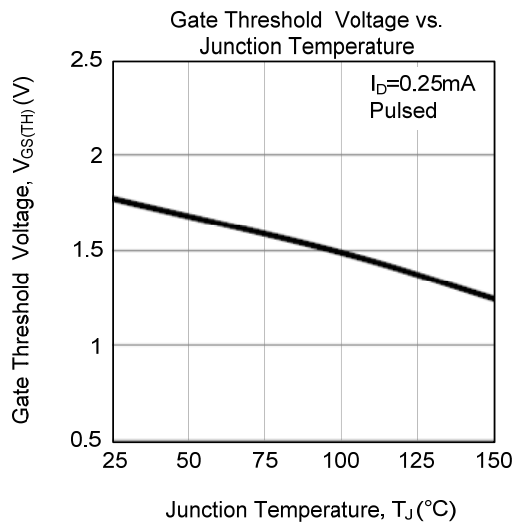


Unclamped Inductive Switching Waveforms

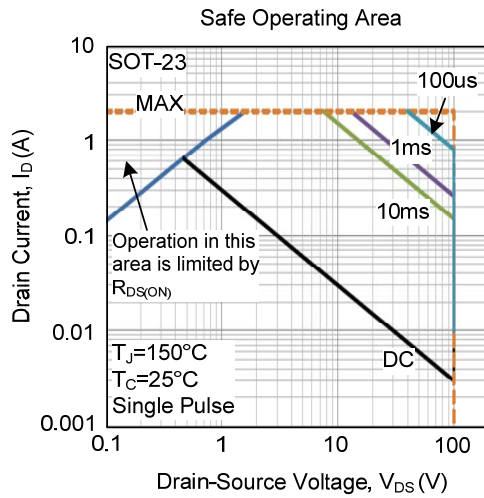
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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